

# PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT										
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT										
<b>CONVEYING PARTY DATA</b>											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Kevin D. Virgil</td> <td>08/04/2010</td> </tr> <tr> <td>Michael L. Reed</td> <td>08/04/2010</td> </tr> </tbody> </table>		Name	Execution Date	Kevin D. Virgil	08/04/2010	Michael L. Reed	08/04/2010				
Name	Execution Date										
Kevin D. Virgil	08/04/2010										
Michael L. Reed	08/04/2010										
<b>RECEIVING PARTY DATA</b>											
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;"><b>Name:</b></td> <td>Teradata US, Inc</td> </tr> <tr> <td><b>Street Address:</b></td> <td>2835 Miami Village Drive</td> </tr> <tr> <td><b>City:</b></td> <td>Miamisburg</td> </tr> <tr> <td><b>State/Country:</b></td> <td>OHIO</td> </tr> <tr> <td><b>Postal Code:</b></td> <td>45342</td> </tr> </table>		<b>Name:</b>	Teradata US, Inc	<b>Street Address:</b>	2835 Miami Village Drive	<b>City:</b>	Miamisburg	<b>State/Country:</b>	OHIO	<b>Postal Code:</b>	45342
<b>Name:</b>	Teradata US, Inc										
<b>Street Address:</b>	2835 Miami Village Drive										
<b>City:</b>	Miamisburg										
<b>State/Country:</b>	OHIO										
<b>Postal Code:</b>	45342										
<b>PROPERTY NUMBERS Total: 1</b>											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th style="width: 70%;">Number</th> </tr> </thead> <tbody> <tr> <td><b>Application Number:</b></td> <td>12850941</td> </tr> </tbody> </table>		Property Type	Number	<b>Application Number:</b>	12850941						
Property Type	Number										
<b>Application Number:</b>	12850941										
<b>CORRESPONDENCE DATA</b>											
<p>Fax Number: (937)439-0693</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 937-242-4727</p> <p>Email: james.stover@teradata.com</p> <p>Correspondent Name: JAMES M. STOVER TERADATA CORPORATION</p> <p>Address Line 1: 2835 MIAMI VILLAGE DRIVE</p> <p>Address Line 4: MIAMISBURG, OHIO 45342</p>											
<b>NAME OF SUBMITTER:</b>	Howard L. Speight										
<p>Total Attachments: 2</p> <p>source=00200120554Assignment#page1.tif</p> <p>source=00200120554Assignment#page2.tif</p>											

CH \$40.00 12850941

501254091

**PATENT**  
**REEL: 024795 FRAME: 0635**

## ASSIGNMENT

WHEREAS, We, Kevin D. Virgil, residing at 1843 Corte Amarillo, Occanside, CA 92056, and Michael L. Reed, residing at 6266 Seaman Street, San Diego, CA 92120, made certain new and useful inventions and improvements for which we executed an application for Letters Patent of the United States on even date herewith, which is entitled SPLITTING POLYGONS WITH INTERIOR RINGS, attorney docket number 20554;

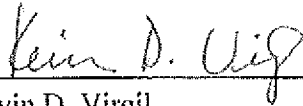
AND WHEREAS, Teradata US, Inc, a corporation organized and existing under and by virtue of the laws of the State of Delaware, and having an office and place of business at 2835 Miami Village Drive, Miamisburg, Ohio 45342 (hereinafter 'Assignee'), is desirous of acquiring the entire right, title and interest in and to said inventions, improvements and application and in and to the Letters Patent to be obtained therefore;

NOW, THEREFORE, to all whom it may concern, be it known that for good and valuable consideration, the receipt and sufficiency whereof is hereby acknowledged, we have sold, assigned, and transferred, and by these presents do sell, assign and transfer unto said Assignee, its successors or assigns, the entire right, title and interest for all countries in and to all inventions and improvements disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent which may be granted there from, and all reissues or extensions of such patents, and in and to any and all applications which have been or shall be filed in any foreign countries for Letters Patent on the said inventions and improvements, including an assignment of all rights under the provisions of the International Convention, and all Letters Patent of foreign countries which may be granted there from; and we do hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent for the aforesaid inventions and improvements to the said Assignee as the assignee of the entire right, title and interest in and to the same, for the use of the said Assignee, its successors and assigns.


AND, for the consideration aforesaid, we do hereby agree that we and our executors and legal representatives will make, execute and deliver any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said Assignee, its successors and representatives all facts known to us relating to said improvements and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable more effectually to secure to and vest in said Assignee, its successors or assigns the entire right, title and interest in and to the said improvements, inventions, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

AND, furthermore, we covenant and agree with said Assignee, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by us and that full right to convey the same as herein expressed is possessed by us.

IN TESTIMONY WHEREOF, I have hereunto set my hand this 4 day of  
August, 2010.

  
\_\_\_\_\_  
Kevin D. Virgil

IN TESTIMONY WHEREOF, I have hereunto set my hand this 4 day of  
August, 2010.

  
\_\_\_\_\_  
Michael L. Reed